

晶采光電科技股份有限公司 AMPIRE CO., LTD.

SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	AM-1280800NHTZQW-T00H
APPROVED BY	
DATE	

- □Approved For Specifications
- □Approved For Specifications & Sample

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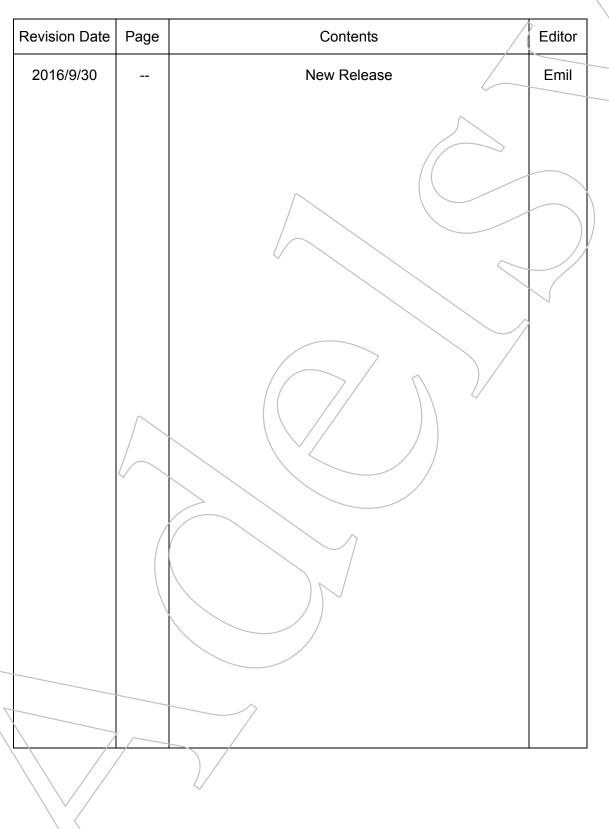
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APPROVED BY	CHECKED BY	ORGANIZED BY
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1.0 General Descriptions

1.1 Introduction

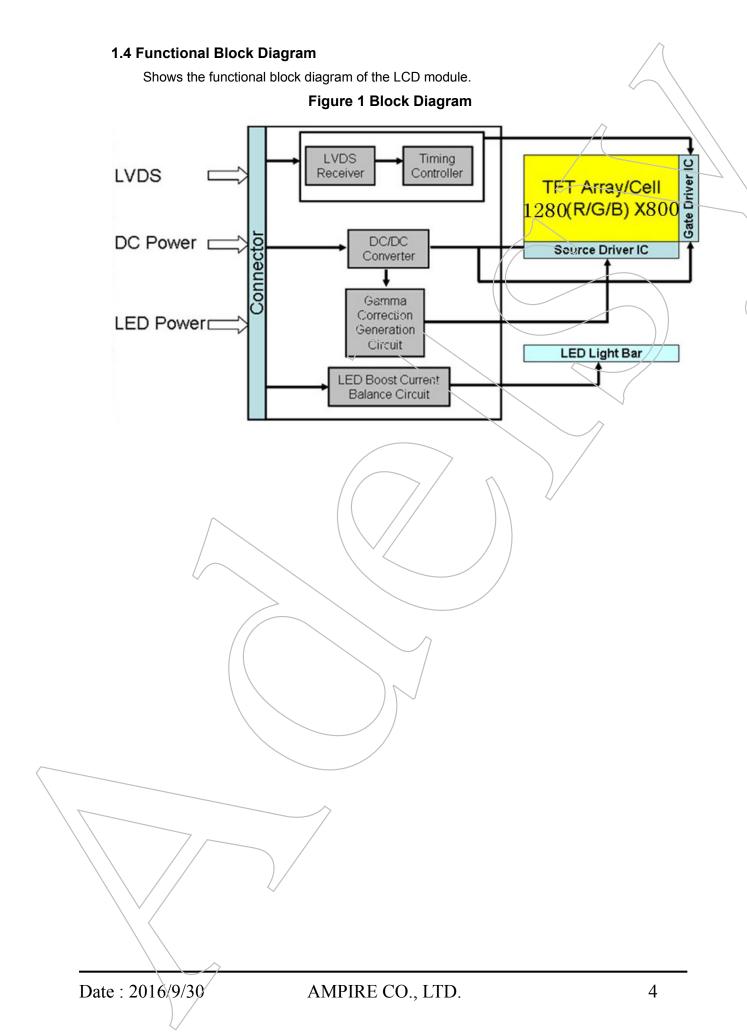
The LCM is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. It is composed of a TFT LCD panel, a backlight system, column driver and row driver circuit. This TFT LCD has a 10.1-inch diagonally measured active display area with WXGA resolution (1280 horizontal by 800 vertical pixels array).

1.2 Features

- 10.1" TFT LCD Panel
- LED Backlight System
- Supported WXGA 1280x800 pixels resolution
- · Compatible with RoHS Standard
- PCAP, USB interface.
- Comp

1.3 Product Summary

Items		Specifications	Unit
Screen Diagonal		10.1	Inch
Active Area		216,96(H) x 135.6(V)	mm
Pixel Format		1280(RGB) x800	-
Pixel Pitch		0.1695(H)×0.1695 (V)	mm
Pixel Arrangement		R.G.B. Vertical Stripe	-
Display Mode		Normally Black	-
White Luminance		300(Typ)	cd /m2
Contrast Ratio		800 : 1 (Typ)	-
Response Time		25	msec
Input Voltage		3.3	V
Outline Dimensions	W/O PCB	229.46(H) x 149.1(V) x3.9(D) (Max)	mm
Outline Dimensions	W/ PCB	229.46(H) x 149.1(V) x5.7(D) (Max)	mm
Electrical Interface (L	ogic)	LVDS	-
Support Color		16.7M/	-
Surface Treatment		Glare, Hard-Coating (3H)	-



2.0 Absolute Maximum Ratings

Table 1 Electrical Absolute Ratings

Item	Symbol	Min	Max	Unit	Conditons
Logic Supply Voltage	VDD	-0.3	7	V	TA=25℃
Supply VLED Voltage	VLED	-0.3	24	V	TA=25°ℂ

Table 2 Reliability Absolute Ratings

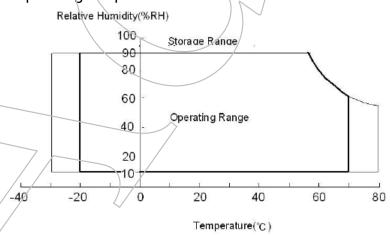
Item	Symbol	Min	Max	Unit	Conditons
Operating Temperature	ТОР	-20	70	°C	Note
Operating Humidity	НОР	1	90	%RH	Note
Operating Temperature	TS/f	-30	80	°C	Note
Storage Humidity	HST		90	%RH	Note

Note: (1) Maximum Wet-Bulb temperature should be 39 degree C and no condensation.

(2) When you apply the LCD module for OA system. Please make sure to keep the temperature of

LCD module is less than 70°C

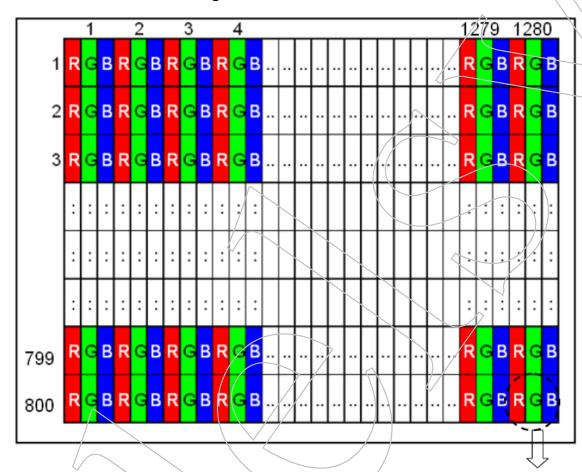
(3) Storage /Operating temperature



3.0 Pixel Format Image

Figure 2 shows the relationship of the input signals and LCD pixel format image/

Figure 2 Pixel Format



R+G+B dots=1 pixel

4.0 Optical Characteristics

The optical characteristics are measured under stable conditions as following notes

Table 2 Optical Characteristics

Item	Conditions		Min.	Тур.	Max.	Unit	Note
	Horizontal	θ∟	(75)	(85)	-	/(
Viewing Angle		θR	(75)	(85)	-	degree	(1),(2),(3)
(CR>10)	Vertical	θт	(75)	(85)	-	3	(' /, (– /, (- /
	vertical	θв	(75)	(85)	-		
Contrast Ratio	Center		(600)	(800)	- ∫	-	(1),(2),(4)
Response Time	Rising		-	1	-/_	ms	
	Falling		-	-	/-/	ms	(1),(2),(5)
	Rising + Fallin	g	-	25	/ (-	ms	
	NTSC		<u> </u>	45	1-	%	(1),(2)
	Red	Χ		0.561		/	
	Red	y		0.334		<u>-</u>) /
Color	Green	x /	Тур.	0.341	Тур.	-	
Chromaticity	Green	y	-0.05	0.568	+0.05	E	(1),(2)
(CIE1931)	Blue	Χ		0.161		- \	(1),(2)
	Blue	у		0.129		-	7
	White	Χ	-	0.313			
	White	у	-	0.329	-		
White Luminance	Center		240	300	-	cd/m^2	(1),(2),(6)
Luminance Uniformity	9Points	(70	75	\\-	// %	(1),(2),(6)

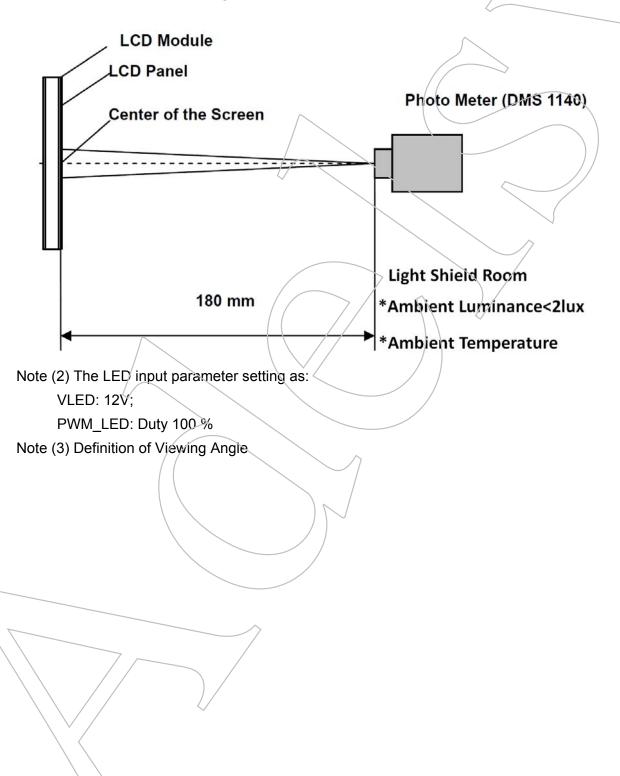


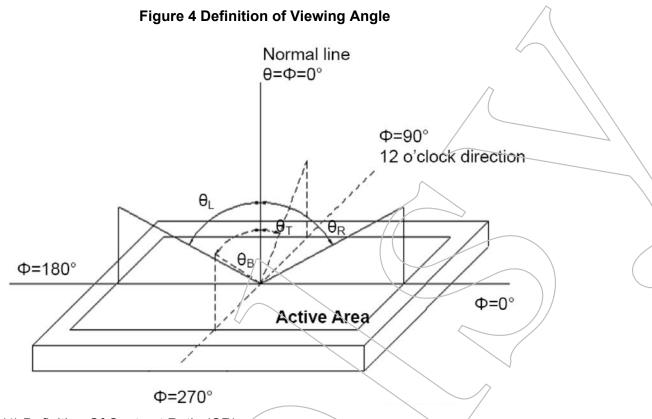
Note (1) Measurement Setup:

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The LCD module should be stabilized at given temperature(25 °C) for 15 minutes to Avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.

Figure 3 Measurement Setup





Note (4) Definition Of Contrast Ratio (CR)

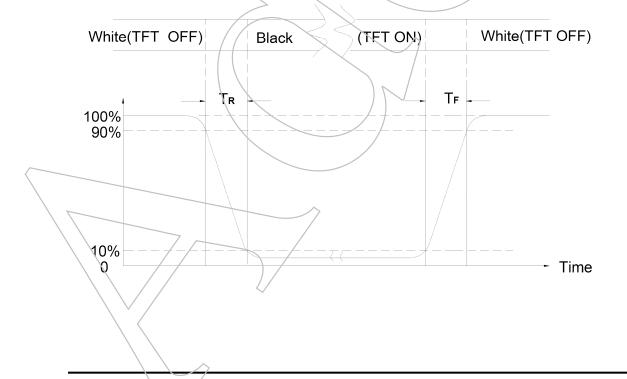
The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L255 / L0

L255: Luminance of gray level 255, L0: Luminance of gray level 0

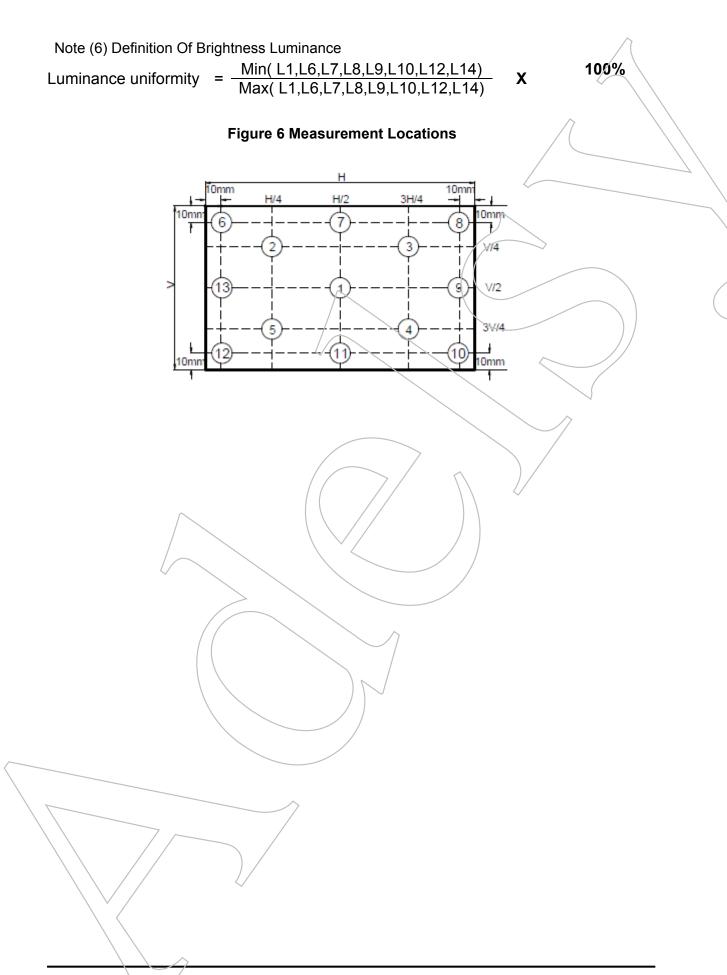
Note (5) Definition Of Response Time (TR, TF)

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Figure 5 Definition of Response Time



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5.0 Backlight Characteristics

5.1 Parameter Guideline Of LED Backlight

Table 3 Parameter Guideline for LED Backlight

Symbol	Parameter		Min.	Тур.	Max.	Units	Condition
VLED	LED Inpu	t	(6)	(12)	(21)	[V]	Ta=25°C Note B
PLED	LED Power Consumption		-	-	(2.5)	W-	Ta=25℃ Note B
VLED PWM	PWM Signal	High	3.0		3.6	V	Ta=25°∁
VLED_PVVIVI	Voltage	Low	0		0.4	>/	1a-25 (
Fpwm	PWM dimm	ing	1000	-	2000	Hz	Ddim≥1%
I PVVIVI	Frequency	y	2000	-	20000	Hz	Ddim≥5%
MED EN	LED Enable	High	3.0		3.6	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
VLED_EN	Voltage	Low	0/		0.4	V_	-
LT	LED Life Time		20K	30K	-	Hours	Ta=25 C Note A

Note A: The LED life time define as the estimated time to 50% degradation of initial luminous.

Note B: A higher LED power supply voltage will result in better power efficiency.

Keep the VLED between 12V and 12.6V is strongly recommended.

Figure 7 LED Rush Current Measure Condition

VLED

OV

VLED rising time

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6.0 Electrical Characteristics

6.1 TFT LCD Module Interface Connector

Table 4 Connector Name / Designation

	•
Item	Description
Manufacturer / Part Number	Starconn / 300E40-0010RA-G3
Mating Model Number	TBD or compatible

Table 5 Signal Pin Assignment

Pin # Oin mad Name Description								
Pin #	Singnal Name	Description	Remarks					
1	NC	Not Connect	-					
2	VDD	Power Supply, 3.3V (typical)	-					
3	VDD	Power Supply, 3.3V (typical)						
4	VDD_EDID	Power Supply for EDID I2C Flash IC						
5	SCL_EDID	I2C Serial Clock for EDID I2C Flash IC						
6	SDA_EDID	I2C Serial Data for EDID I2C Flash IC						
7	NC	Not Connect						
8	LV0N	-LVDS differential data input						
9	LV0P	+LVDS differential data input						
10	GND	Ground						
11	LV1N	-LVDS differential data input						
12	LV1P	+LVDS differential data input	7					
13	GND	Ground	\bigcirc					
14	LV2N	-LVDS differential data input						
15	LV2P	+LVDS differential data input						
16	GND	Ground						
17	LVCLKN	-LVDS/differential/data input						
18	LVCLKP	+LVD\$ differential data input						
19	GND	Ground						
20	LV3N	-LVDS differential data input						
21	LV3P	+LVDS differential data input						
22	GND	Ground						
23	LED_GND	Ground for LED Driving						
24	LED_GND	Ground for LED Driving						
25	LED_GND //	Ground for LED Driving						
26	NC	Not Connect						
27	LED_PWM	PWM Input signal for LED driver						
28	LED_EN	LED Enable Pin						
29	CABC_EN	Content Adaptive Brightness Control	Enable: Hi					
	_ \	Function Enable	Disable:Lo					
30	NC	Not Connect						
31	LED_VCC	Power Supply for LED Driver						
32	LED_VCC	Power Supply for LED Driver						
33	LED_VCC	Power Supply for LED Driver						
34	NC	Not Connect						
35	BIST	BIŞ/T pin						
36-40	NC /	Not Connect						
-			•					

Note: All input signals shall be low or Hi-resistance state when VDD is off.

6.2 LVDS Receiver

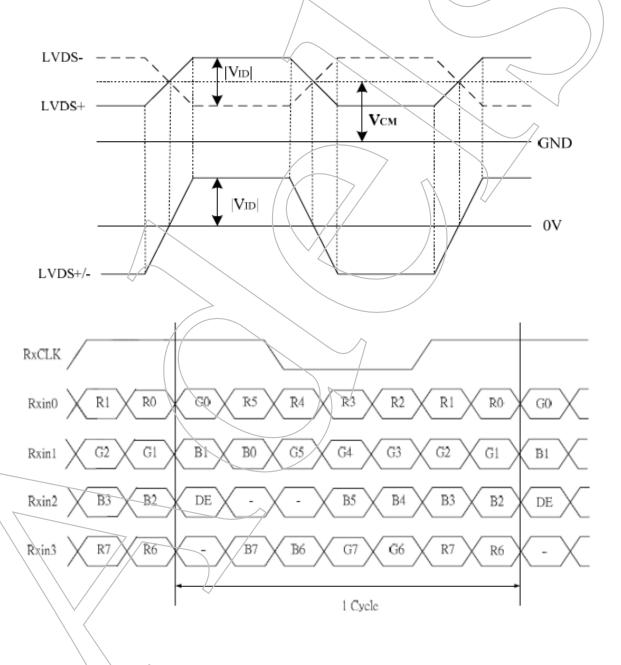
6.2.1 Signal Electrical Characteristics For LVDS Receiver

Table 7 LVDS Receiver Electrical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Differential Input High	Vth	-	-	+100	mV	V _{CM} =+1.2V
Differential Input Low	VtI	-100	-	-	mV	V _{CM} =+1.2V
Magnitude Differential Input	V _{ID}	200	-	400	m√	
Common Mode Voltage	V _{CM}	0.3+ (VID/2)	-	VDD-1.2-(VID/2)	V	-
Common Mode Voltage	ΔV_{CM}	-	-	50	m√	V _{CM} =+1.2V

Note (1) Input signals shall be low or Hi-Z state when VDD is off.

(2) All electrical characteristics for LVDS signal are defined and shall be measured at the interface connector of LCD.



7. Touch Panel

7.1 FEATURE

Construction: Touch Sensor, Touch Controller and FPC.

Touch Controller: ILI2301S + ILIM2V

Resolution: 3840 x 2944

Interface: USB

Power Supply Voltage: 5V

Touch Finger Number: 10

7.2 Electrical Absolute Max Rating

ltem	Symbol	Valu	ies	UNIT	Note	
item	Sylligor	Min.	Max.	ONIT		
Power Supply voltage	VCC	-0.3	5.5	V	GND =0V	

7.3 ELECTRICAL CHARACTERISTICS

Specify the normal operating condition

(GND=0V)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage	vcc	\ -	5.0		V	
Power Consumption	Ivcc		(20)		mA	

7.4 INTERFACE PIN ASSIGNMENT

Pin	Name	Description
1	VCC	Power supply 5.0V
2	DA+	USB Data+
3	DA-	USB Data-
4	N.C	N.C
5	GND	Power GND
6	GND	Power GND

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8.0 Interface Timings

Date: 2016/9/30

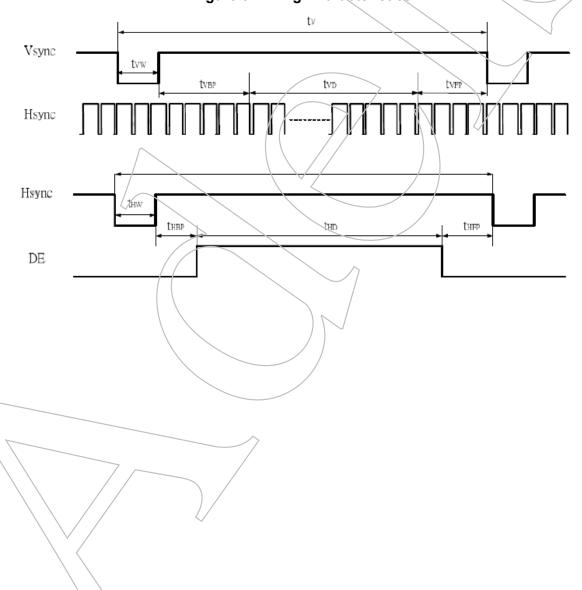
8.1 Timing Characteristics

Interface Timings

Parameter	Symbol	Unit	Min.	Тур.	Max.
Frame Rate		Hz	-	60	-
Frame Period	t∨	line	(815)	(823)	(1023)
Vertical Display Time	t∨D	line		800	
Vertical Blanking Time	tvw+tvbp+tvfp	line	(15)	(23)	(33)
1 Line Scanning Time	tн	clock	(1410)	(1440)	(1470)
Horizontal Display Time	t HD	clock		1280	
Horizontal Blanking Time	thw+thbp+thfp	clock	(60)	(160)	(190)
Clock Rate	1/Tc	MHz	(68.9)	(71.1)	(73.4)

8.2 Timing Diagram of Interface Signal (DE-mode)

Figure 8 Timing Characteristics



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9.0 Power Consumption

Input power specifications are as follows.

Table 8 Power Consumption

				_			//
Item	Symbol	Min	Тур	Max	Unit	Note	
LCD Drive Voltage		VDD	3.0	3.3	3.6	y	(2),(4)
VDD Current	White Pattern	IDD		0.27		A	(3),(4)
VDD Power Consumption	White Pattern	PDD			1,0	W	(3),(4)
LED Power Consu	PLED			2.5	W	(3),(4)	
Rush Current	Irush (1.5	A	(1),(4),(5)	
Allowable Logic/LC Voltage	VDDrp			300	mV	(4)	

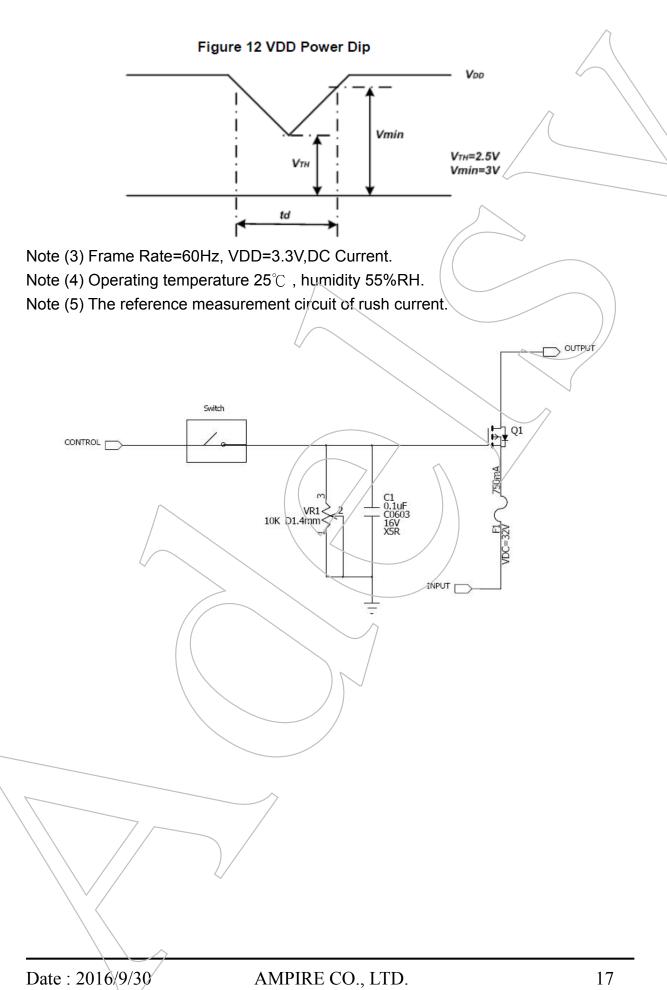
Note 1.Measure Condition

90%
3.3V
VDD rising time
VDD rising time

Note 2.VDD Power Dip Condition

If VTH<VDDRVmin, then tdR10ms; when the voltage return to normal our panel must revive automatically.

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10.0 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.

Vin 10% T2 T3

LVDS data

Vin_Led PWM

EN

Table 9 Power Sequencing Requirements

Parameter	Symbol	Unit	Min	Тур.	Max
VIN Rise Time	/ /1	ms	0.5	-	10
VIN Good to Signal Valid	\12	ms	30	1	90
Signal Valid to Backlight On	T3	ms	200		
Backlight Power On Time	T4	ms	0.5		
Backlight VDD Good to System PWM On	T5	ms	10		
System PWM ON to Backlight Enable ON	16	ms	10		
Backlight Enable Off to System PWM Off	T7 /	ms	0		
System PWM Off to B/L Power Disable	18	ms	10		
Backlight Power Off Time	/ T9	ms		10	30
Backlight Off to Signal Disable	/T10	ms	200		
Signal Disable to Power Down	T11	ms	0		50
VIN Fall Time	T12	ms		10	30
Power Off	T13	ms	500		

11 USE PRECAUTIONS

11.1 Handling precautions

- 1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
- 2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
- 3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
- 4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

11.2 Installing precautions

- 1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. $1M\Omega$ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
- 2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- 3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- 4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

11.3 Storage precautions

- 1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
- 3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

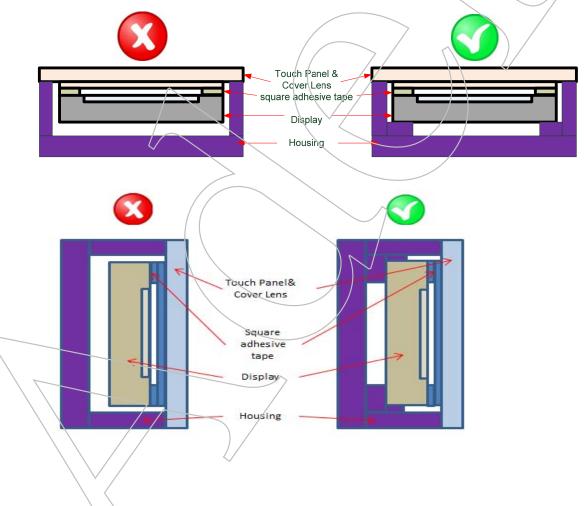
11.4 Operating precautions

- 1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
- 2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- 3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- 4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- 5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- 6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.

- 7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
- 8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

11.5 Mechanism

- (1) Please mount LCD module by using mounting holes arranged in four corners tightly.
- (2) The square adhesive tape which is between the touch panel and display can't provide well supporting in the long term and high ambient temperature condition. Whether upright or horizontal position the support holder which is in the back side of the display is needed. Do not let the display floating.



11.6 Other

- 1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- 2) Do not keep the LCD at the same display pattern continually. The residual image will happen and it will damage the LCD. Please use screen saver

3) AMIPRE will provide one year warrantee for all products and three months warrantee for all repairing products.

